

Meeting Minutes PDCC Ad Hoc
Prepared by: Chad Jones
18-19 September 2024
Hamburg, Germany

18 September
10:15 CET

10:15 Meeting called to order.

Meeting started by the Ad Hoc Chair, Chad Jones.

10:16 The Chair starts reviewing agenda slides.

10:16 The Chair covered the IEEE SA Patent Policy, code of ethics and conduct, individual process, equitable consideration of all viewpoints, and IEEE SA Copyright Policy (slides 4-8 in the agenda deck).

10:19 The Chair informs the group that minutes for the 31 July meeting are posted, asked if anyone that wanted to review the minutes hadn't had the chance to review, and asked if there were any changes to be made to these minutes. None responded. The minutes were approved by unanimous consent. The Chair instructed the webmaster to change the status of the 31 July 2024 minutes to confirmed.

10:20 The first agenda item was the IEC TC 64 MT2 October meeting. A presentation was provided for attendees follow along:

https://www.ieee802.org/3/ad_hoc/PDCC/public/Law_1_0924.pdf.

The MT2 liaison walked the group through some of the comments that might require IEEE 802.3 attention. The summary of the review was to direct the liaison to continue to support the IEEE 802.3 positions that have been established throughout the engagements we've had with these external organizations. A slide was generated to show to the WG in the closing meeting to get their approval: https://www.ieee802.org/3/ad_hoc/PDCC/public/Law_2_0924.pdf.

10:46 The second agenda also involved IEC TC 64 MT2, and is covered in the presentation linked above. The issue is a one that has lingered with the PDCC unsuccessfully trying to get action from disparate IEC groups, and is covered on slides 3 and 4 of the presentation. In the past, our requests have went unanswered as IEEE 802.3 did not have the proper "group access" to make the requests. But now there is a maintenance project and we have a liaison officer assigned for this effort, opening a new opportunity to make the request and not have it dismissed unanswered. A liaison letter was created to address:

https://www.ieee802.org/3/minutes/sep24/outgoing/IEEE_802d3_to_IEC_TC64_0924_1_draft_D3p0_Redacted.pdf.

A second liaison letter was generated

11:08 The third agenda item was BS 7671 Amendment 4, which is open for comments, closing on 3 November 2024. See the 31 July minutes for more details on the effort and how to access

the draft. The ad hoc reviewed sections of the text that might warrant comments from 802.3. The chair took the action to compile these into a list for review in a future PDCC ad hoc meeting.

11:30 having exhausted the scheduled meeting time, the Ad hoc recessed for the day as some ad hoc members agreed to work on the liaison letters overnight, bringing them back the next morning for ad hoc review and approval.

19 September
8:00 CET

8:01 Back in session. The chair did a quick review of the meeting guidelines from the agenda file.

8:03 The ad hoc reviewed the draft liaison letter to TC 64 proposing a new “717” section in 60364 to cover SPoE.

8:19 The ad hoc reviewed the draft liaison letter to TC 64 regarding the “SELV/PELV/ES1” contradictions between the TC 64 and TC 108. The liaison was addressed to TC 64 but also included leadership for TC 108.

8:34 The ad hoc reviewed the directions to the liaison for the TC 64/MT 2 meeting. These can be found in the PDCC closing report to the working group:
https://www.ieee802.org/3/minutes/sep24/PDCC_adhoc_close_report_0924.pdf.

The ad hoc chair was directed to present the two liaison letters and the directions for the liaison officer to the WG and make one motion to approve all three.

8:45 The next scheduled meeting is at the standard weekly Wednesday meeting, scheduled for 25 September 2024 at 1PM EDT. See the 802.3 call and meeting calendar for details:
<https://www.ieee802.org/3/calendar.html>.

8:46 The chair asked if there was any other business and it was pointed out that ISO/IEC 16750 is writing a section about 48V DC/DC supply systems and that IEEE 802.3 may want to get involved. It was proposed that the group pursue a Category A liaison in the November meeting.

8:48 The Chair asked if there was any other business, none responded. Having exhausted the agenda, the meeting was adjourned.

Attendance (from Webex and IMAT – noted by W, I):

Name	Employer; Affiliation	Present 9/18	Present 9/19
Alireza Razavi	Marvell; Marvell	I	
Amir Bar-Niv	Aquantia Corp; Marvell	I	
Ariel Lasry	Qualcomm Technologies, Inc; Qualcomm Technologies, Inc	W,I	
Bert Bergner	TE Connectivity Germany GmbH; TE Connectivity	I	
Brian Murray	Analog Devices Inc.; Analog Devices Inc.	W,I	
Chad Jones	Cisco Systems, Inc.; Cisco Systems, Inc.	W,I	W,I

Name	Employer; Affiliation	Present 9/18	Present 9/19
David Law	Hewlett Packard Enterprise; Hewlett Packard Enterprise	W,I	W,I
Francois Beauregard	Belden Canada ULC; Belden	W,I	W,I
Geoff Thompson	GraCaSI S.A.; INDEPENDENT	W,I	
George Zimmerman	CME Consulting, Inc.; CME Consulting/ADI, APL Group, Cisco, Marvell, OnSemi, SenTekSe LLC, Sony	W,I	
Gergely Huszak	Self; Kone	W,I	
Hans Lackner	QoSCom GmbH; QoSCom GmbH	W,I	
Hector Alberti Arroyo	Analog Devices Inc.; Analog Devices Inc.	W,I	
Heiko Strohmeier	Robert Bosch GmbH; Robert Bosch GmbH	W,I	
James Withey	Fluke Corporation; Fluke Corporation	W,I	W,I
Jon Lewis	Dell Technologies; Dell Technologies	I	
Jörg Kock	NXP Semiconductors; NXP Semiconductors	W,I	W,I
Mary Sue Haydt	Microchip Technology, Inc.; Microchip Technology, Inc.	W,I	
Masaki Yasukawa	NEC Magnus Communications, Ltd.; NEC Magnus Communications, Ltd.	W,I	W
Michael Paul	Analog Devices Inc.; Analog Devices Inc.	W,I	
Michal Brychta	Analog Devices Inc.; Analog Devices Inc.	W,I	
Peter Jones	Cisco Systems, Inc.; Cisco Systems, Inc.	W,I	
Ragnar Jonsson	Marvell Semiconductor, Inc.; Marvell Semiconductor, Inc.	I	
Ramanjit Ahuja	ON Semiconductor; ON Semiconductor	W,I	
Steffen Graber	Pepperl+Fuchs SE; Pepperl+Fuchs SE	W,I	W,I
Stephan Schreiner	Rosenberger Hochfrequenztechnik GmbH & Co. KG; Rosenberger	W,I	
Thomas Mueller	Rosenberger; Rosenberger	W,I	
Tingting Zhang	Huawei Technologies Co., Ltd; Huawei Technologies Co., Ltd	W,I	
TJ Houck	Marvell; Marvell	I	
Tomohiro Kikuta	Orbray Co., Ltd.; Orbray Co., Ltd.	W,I	
Valerie Maguire	Copperopolis; Copperopolis, affiliated with CME Consulting	W,I	
William Lo	Axonon Inc.; Axonon Inc.	I	
Yan Zhuang	Huawei Technologies Co., Ltd; Huawei Technologies Co., Ltd	W,I	
Yasuhiro Hyakutake	Orbray Co., Ltd.; Orbray Co., Ltd.	W,I	